Docket No.: 1408.028

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Tab settings	• · · · · · · · · · · · · · · · · · · ·			
To the Director of the United States Patent and Trauerrain Can				
1. Name of conveying party(ies):	Name and address of receiving party(ies):			
EUN, Jae-Soon KWAK, Yong-Geun	Name: EUN, Jae-Soon			
KIM, Dae-Keun	. 4			
CHAE, Soo-Wan	Address: 105-202 Seoho Apt., 337			
Additional names(s) of conveying party(ies) attached?	Songchundong 1-ga			
3. Nature of conveyance:				
⊠ Assignment □ Merger				
☐ Security Agreement ☐ Change of Name	City: Deokjin-gu, Chonju-si State/Prov.: Chonbuk			
☐ Other	Country: Korea ZIP: 561-765			
	•			
Execution Date: October 29, 2003	Additional name(s) & address(es) attached? ⊠ Yes □ No			
If this document is being filed together with a new application Patent Application No. Filing date 11/14/2003 SSITHIB1 00000057 10704940 01 FC:8021 40.00 0P	B. Patent No.(s)			
Additional numbers at	tached? 🔲 Yes 🗵 No			
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:			
Name: Kathy Smith Dias	7. Total fee (37 CFR 3.41):\$ 40.00			
Registration No. 41,707	☑ Enclosed - Any excess or insufficiency should be			
Address: Heslin Rothenberg Farley & Mesiti P.C.	credited or debited to deposit account			
5 Columbia Circle	☐ Authorized to be charged to deposit account			
	8. Deposit account number:			
City: Albany State/Prov.: New York	08-1935			
Country: <u>U.S.A.</u> ZIP: <u>12203</u>	(Attach duplicate copy of this page if paying by deposit account)			
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9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.				
Kathy Smith Dias Kathy	Smith Sus November 10, 2003			
Name of Person Signing Signature Date				
Total number of pages including cover sheet, attachments, and document:				

Docket No.: 1408.028

RECORDATION FORM COVER SHEET

No. 2 (Continued)

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Wanju-gun

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Name: JUNG, Young-Hoon Address: 101, Samjin Villa Apt.

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Name: ZEE, Ok-Pyo

Address: 103-1001, Hyundai Apt.

431, Doryong-dong, Yuseong-gu

Daejeon 305-340 KOREA

ASSIGNMENT

WHEREAS, We(I), <u>EUN</u>, <u>Jae-Soon</u>; <u>KWAK</u>, <u>Yong-Geun</u>; <u>KIM</u>, <u>Dae-Keun</u>; <u>and CHAE</u>, <u>Soo-Wan</u>, citizens of the Republic of Korea, residing at <u>105-202</u>, <u>Seoho Apt.</u>, <u>337</u>, <u>Songchundong 1-ga</u>, <u>Deokjin-gu</u>, <u>Chonju-si</u>, <u>Chonbuk 561-765</u>; <u>113-107</u>, <u>Jinbukwoosung Apt.</u>, <u>Jinbuk-dong</u>, <u>Deokjin-gu</u>, <u>Chonju-si</u>, <u>Chonbuk 561-783</u>; <u>102-205</u>, <u>Dongkuk Apt.</u>, <u>582-1</u>, <u>Yueui-dong</u>, <u>Deokjin-gu</u>, <u>Chonju-si</u>, <u>Chonbuk 561-330</u>; <u>and 567-5</u>, <u>Sangsam-ri</u>, <u>Yongjin-myeon</u>, <u>Wanju-gun</u>, <u>Chonbuk 565-812</u>, respectively, have invented certain new and useful improvements in <u>Pharmaceutical compositions comprising chelidonine or derivatives thereof</u> for which we have executed an application for Letters Patent of the United States, on <u>October 29</u>, <u>2003</u> and

WHEREAS, EUN, Jae-Soon; KWAK, Yong-Geun; KIM, Dae-Keun; CHAE, Soo-Wan; JUNG, Young-Hoon; and ZEE, Ok-Pyo, having offices at 105-202, Seoho Apt., 337, Songchundong 1-ga, Deokjin-gu, Chonju-si, Chonbuk 561-765; 113-107, Jinbukwoosung Apt., Jinbuk-dong, Deokjin-gu, Chonju-si, Chonbuk 561-783; 102-205, Dongkuk Apt., 582-1, Yueui-dong, Deokjin-gu, Chonju-si, Chonbuk 561-330; 567-5, Sangsam-ri, Yongjin-myeon, Wanju-gun, Chonbuk 565-812; 101, Samjin Villa Apt., 1505-5, Seocho-dong, Seochogu, Seoul 137-070; and 103-1001, Hyundai Apt., 431, Doryong-dong, Yuseong-gu, Daejeon 305-340, are desirous of obtaining the entire right, title and interest in, to and under the said improvements and the said application;

NOW, THEREFORE, in consideration of the sum of One Thousand Won to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, We the said <u>EUN</u>, <u>Jae-Soon</u>; <u>KWAK</u>, <u>Yong-Geun</u>; <u>KIM</u>, <u>Dae-Keun</u>; <u>and CHAE</u>, <u>Soo-Wan</u>, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said <u>EUN</u>, <u>Jae-Soon</u>; <u>KWAK</u>, <u>Yong-Geun</u>; <u>KIM</u>, <u>Dae-Keun</u>; <u>CHAE</u>, <u>Soo-Wan</u>; <u>JUNG</u>, <u>Young-Hoon</u>; <u>and ZEE</u>, <u>Ok-Pyo</u>, their successors, legal representatives and assigns, the entire right, title and interest in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent which may be granted thereon and

all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for said improvements in the United States, and we hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said improvements to the said <u>EUN, Jae-Soon; KWAK, Yong-Geun; KIM, Dae-Keun; CHAE, Soo-Wan; JUNG, Young-Hoon; and ZEE, Ok-Pyo,</u> their successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that We have full right to convey the entire interest herein assigned, and that We have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that We will communicate to the said <u>EUN</u>, <u>Jae-Soon</u>; <u>KWAK</u>, <u>Yong-Geun</u>; <u>KIM</u>, <u>Dae-Keun</u>; <u>CHAE</u>, <u>Soo-Wan</u>; <u>JUNG</u>, <u>Young-Hoon</u>; <u>and ZEE</u>, <u>Ok-Pyo</u>, their successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said <u>EUN</u>, <u>Jae-Soon</u>; <u>KWAK</u>, <u>Yong-Geun</u>; <u>KIM</u>, <u>Dae-Keun</u>; <u>CHAE</u>, <u>Soo-Wan</u>; <u>JUNG</u>, <u>Young-Hoon</u>; <u>and ZEE</u>, <u>Ok-Pyo</u>, their successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in the United States.

of October, 2003.		
	EjneSo	m
	[1st INVENTOR) EUN, J	ae-Soon
Witness	LEE, Eun Jin	
Witness	KYUNNG, Kwang Hyun	

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 29th day

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 29th day of October, 2003.

	K	wake
	[2 nd INVENTOR]	KWAK, Yong-Geun
	chh	
Witness	LEE, Fun Jin	
Witness	KYUNNG, Kwang Hyun	

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 29th day of October, 2003.

[3nd INVENTOR]

KIM, Dae-Keun

Witness

LEE, Eun Jin

Witness

KYUNNG, Kwang Hyun

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 29th day of October, 2003.

[4nd INVENTOR]

CHAE, Soo-Wan

Witness

LEE, Eun Jin

RECORDED: 11/10/2003

Witness

KYUNNG, Kwang Hyun